NSN 5962-00-530-4664

Memory Microcircuit - Page 1 of 1



View Online at https://aerobasegroup.com/nsn/5962-00-530-4664 **Body Length:** Between 0.890 inches and 0.960 inches **Body Width:** Between 0.275 inches and 0.295 inches **Body Height:** Between 0.025 inches and 0.150 inches **Maximum Power Dissipation Rating:** 400.0 milliwatts **Operating Tempurature Range:** -25.0/+85.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Monolithic and hermetically sealed and positive outputs and w/enable and low power and w/storage **Inclosure Material:** Ceramic and glass **Inclosure Configuration:** Dual-in-line **Output Logic Form:** P-type metal oxide-semiconductor logic **Input Circuit Pattern:** 14 input **Terminal Surface Treatment:** Solder **Memory Device Type:** Rom **Test Data Document:** 94117-310180 drawing (this is the basic governing drawing, such as a contractor drawing, original equipment manufacturer drawing, etc.; excludes any specification, standard or other document that may be referenced in a basic governing drawing) **Terminal Type And Quantity:** 18 printed circuit Shelf Life: N/a **Unit Of Measure:** Demilitarization:

Yes - demil/mli

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